



# IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

## Patent Application

In Re: PAYNE, Jason J., et al.  
Serial No: 10/603048  
Filed: 6/24/2003  
For: Printed Circuit Board For High Speed, High Density Electrical Connector With Improved Cross-Talk Minimization, Attenuation And Impedance Mismatch Characteristics

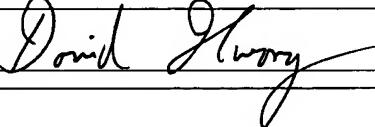
Group: 2831

Examiner:

May 18, 2004

### CERTIFICATE OF MAILING OR TRANSMISSION

I, David H. Hwang, Reg. No. 38,697, certify that this correspondence was placed in an envelope addressed to the COMMISSIONER FOR PATENTS, Box Missing Parts, P.O. Box 1450, Alexandria, VA 22313-1450, and I have a reasonable basis to believe that it will be deposited with the US Postal Service as first class mail, postage prepaid, to the U.S. Patent and Trademark Office on or before May 18, 2004, or

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### PETITION FOR EXTENSION OF TIME

Please extend the due date for responding to the Notice to File Missing Parts previous Action mailed on March 1, 2004 to **June 1, 2004**. Please charge the fees of \$110.00 to Teradyne, Inc.'s Deposit Account No. **20-0515**.

Respectfully Submitted,



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